

Docket No. 618902001410
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Chun H. FAN et al.

Application No. 10/681,983

Confirmation No. 8846

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Art Unit: 2826

For: MULTIPLE LEADFRAME LAMINATED IC
PACKAGE

Examiner: Leonardo Andujar

AMENDMENT UNDER 37 CFR 1.116

MS AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated June 15, 2007, please amend this application as follows.

Amendments to the Specification begin on page 2.

Amendments to the claims begin on page 3.

Remarks begin on page 5.